Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	604	(die adj pad) with holes	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 15:14
L2	10	(die adj pad) with holes with stress	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 15:14
S1	0	"10050156187"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 15:20
S2	2	"20050156187"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:32
<b>S3</b>	6	("6291274" "6558980" "6872661").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:43
S4	4	"6847103"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:34
S5	9905	die adj pad	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:43

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S6	387533	(mold or molded or molding) with resin	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:44
S7	405788	light adj (emitting or emission)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:54
S8	1054393	S7 or LED	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 08:40
S9	4638	S8 and (die with bond\$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:45
S10	147	S5 and S6 and S9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 16:45
S11	56	(LED or (light adj (emitting or emission))) with (die adj pad) with bond\$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:00
S12	13712	(LED or (light adj (emitting or emission))) with bond\$5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:00

S13	1717	(LED or (light adj (emitting or emission))) with (pad with bond\$5)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:20
S14	517	S13 and resin	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:01
S15	479	S14 not (S10 or S11)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:01
S16	1566	(LED or (light adj (emitting or emission))) with ((electrode or lead) with (paste or solder))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:21
S17	348	S16 and lamp	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:21
S18	46	(Isokawa with Shinji) and LED	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/29 17:30
S19	6	("3935501"   "5227662"   "5936264"   "6066861"   "6180962"   "6228676"). PN. OR ("6847116").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/29 17:36

S20	405788	light adj (emitting or emission)	US-PGPUB;	OR	ON	2006/08/30 10:16
320		ight adj (emitting of emission)	USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OK .	ON	2000/08/30 10:16
S21	1054393	S20 or LED	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 08:40
S22	1037	(die adj pad) with electrode	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 08:49
S23	106	S21 and S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 08:41
S24	4333	(die adj pad) with (lead\$1frame or (lead near frame))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:22
S25	221	S21 and S24	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ŌΝ	2006/08/30 08:49
S26	168	S25 not S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 08:49

S27	3	("5748658"   "5821532").PN. OR ("6441402").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/30 09:11
528	26151	(bond\$4 or paste or solder) with (lead\$1frame or (lead near frame))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 09:14
529	2516	S21 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 09:14
S30	1664	S29 and S20	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 09:14
S31	1009	S30 and resin	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 09:14
S32	24506	((light adj (emitting or emission)) or LED) with chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:16
S33	4462	chip with (die adj pad)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:16

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S34	163	S32 and S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:17
S35	5717	(die adj pad) with (lead)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:22
S36	283	S21 and S35	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:22
S37	182	S36 and mold\$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:22